



SEA & LAND ELECTRONIC CORP.

www.sealand-pptc.com



ALPHA-TOP TECHNOLOGY CORP.

www.alpha-top.cn

APPROVAL SHEET

MODEL NO.:

SL0805075

CUSTOMER:

CUSTOMER'S APPROVAL:

AUTHORIZED SIGNATURE/STAMP:

DATE

MANUFACTURER:

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Submitted by:

Chen

Approved by:

YC Lin

DATE:

29-May-24

SEA & LAND ELECTRONIC CORP.

Features

- Surface Mount Devices
- Lead free device
- Size 2.0*1.2 mm / 0.08*0.05 inch
- Surface Mount packaging for automated assembly

Applications

- Almost anywhere there is a low voltage power supply, up to 15V and a load to be protected, including:
- Computer mother board, Modem, USB hub
- PDAs & Charger, Analog & digital line card
- Digital cameras, Disk drives, CD-ROMs,

Alpha-Top (Sea & Land Alliance)

Performance Specification

Model	Marking	V _{max} (Vdc)	I _{max} (A)	I _{hold} @25°C (A)	I _{trip} @25°C (A)	P _d Typ. (W)	Maximum Time To Trip		Resistance		Agency Approval	
							Current	Time (Sec)	R _i _{min} (Ω)	R _{1max} (Ω)	UL	TUV
SL0805075		6	50	0.75	2.80	1.0	8.0	0.3	0.0090	0.1500	✓	

I_{hold} = Hold Current. Maximum current device will not trip in 25°C still air.
I_{trip} = Trip Current. Minimum current at which the device will always trip in 25°C still air.
V_{max} = Maximum operating voltage device can withstand without damage at rated current (I_{max}).
I_{max} = Maximum fault current device can withstand without damage at rated voltage (V_{max}).
P_d = Power dissipation when device is in the tripped state in 25°C still air environment at rated voltage.
R_i_{min/max} = Minimum/Maximum device resistance prior to tripping at 25°C.
R_{1max} = Maximum device resistance is measured one hour post reflow.
CAUTION : Operation beyond the specified ratings may result in damage and possible arcing and flame.

Environmental Specifications

Test	Conditions
Passive aging	+85°C, 1000 hrs.
Humidity aging	+85°C, 85% R.H. , 168 hours
Thermal shock	+85°C to -40°C, 20 times
Resistance to solvent	MIL-STD-202,Method 215
Vibration	MIL-STD-202,Method 201
Ambient operating conditions : - 40 °C to +85 °C	
Maximum surface temperature of the device in the tripped state is 125 °C	
In case of special use,please contact our engineer	

Agency Approvals :



E201504(Alpha-Top)/E319079(Sea&Land)

Regulation/Standard:



2015/863/EU



EN14582

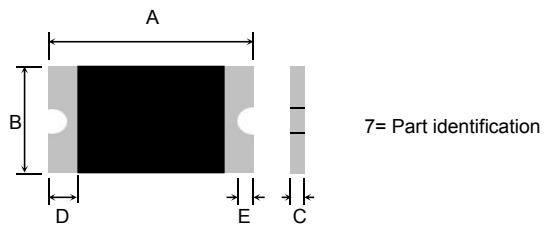
I_{hold} Versus Temperature

Model	Maximum ambient operating temperature (T _{mao}) vs. hold current (I _{hold})								
	-40°C	-20°C	0°C	25°C	40°C	50°C	60°C	70°C	85°C
SL0805075	1.1	1.0	0.8	0.75	0.7	0.6	0.5	0.4	0.33

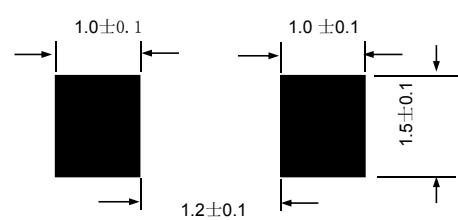
Construction And Dimension (Unit:mm)

Model	A	B	C	D	E
	Min.	Max.	Min.	Max.	Min.
SL0805075	1.90	2.50	1.20	1.80	0.40
					0.80
				0.20	0.10

Dimensions & Marking



Recommended Pad Layout (mm)



Termination Pad Characteristics

Terminal pad materials :

Tin-plated Nickel-Copper

Terminal pad solderability :

Meets EIA specification RS186-9E and ANSI/J-STD-002 Category 3.

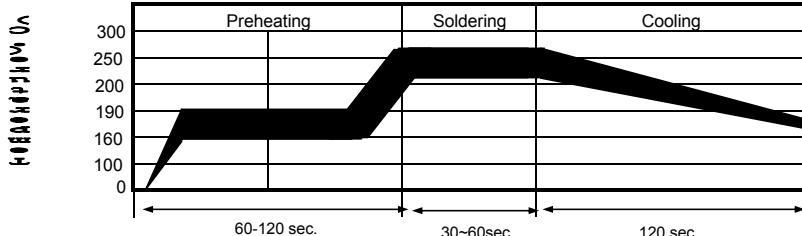
Rework

Use standard industry practices, the removal device must be replaced with a fresh one.

 **WARNING:**

- Use PPTC beyond the maximum ratings or improper use may result in device damage and possible electrical arcing and flame.
- PPTC are intended for protection against occasional over current or over temperature fault conditions and should not be used when repeated fault conditions or prolonged trip events are anticipated.
- Device performance can be impacted negatively if devices are handled in a manner inconsistent with recommended electronic, thermal, and mechanical procedures for electronic components.
- Use PPTC with a large inductance in circuit will generate a circuit voltage ($L \frac{di}{dt}$) above the rated voltage of the PPTC.
- Avoid impact PPTC device its thermal expansion like placed under pressure or installed in limited space.
- Contamination of the PPTC material with certain silicon based oils or some aggressive solvents can adversely impact the performance of the devices. PPTC SMD can be cleaned by standard methods.
- Requests that customers comply with our recommended solder pad layouts and recommended reflow profile. Improper board layouts or reflow profile could negatively impact

Recommended Solder Reflow Conditions



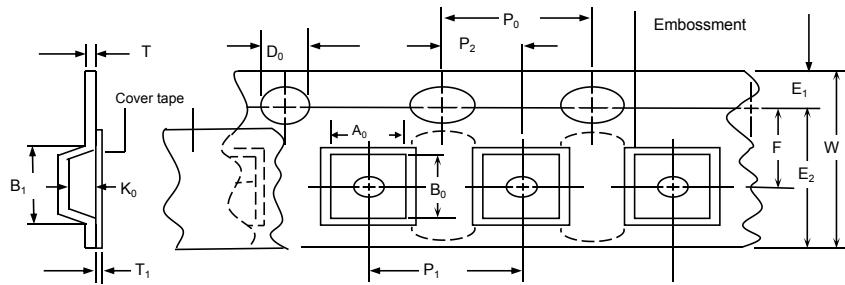
- Recommended reflow methods : IR, vapor phase oven, hot air oven.
- Devices are not designed to be wave soldered to the bottom side of the board.
- Recommended maximum paste thickness is 0.25 mm (0.010 inch).
- Devices can be cleaned using standard method and solvents.

Note : If reflow temperatures exceed the recommended profile, devices may not meet the performance requirements.

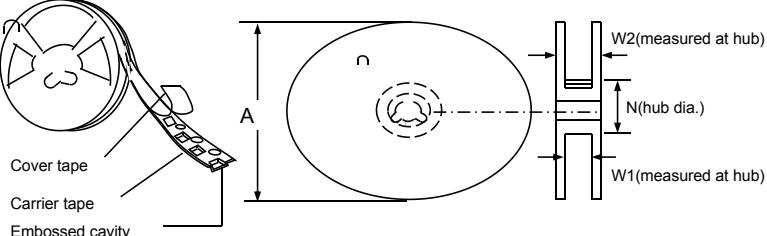
Tape And Reel Specifications (mm)

Governing Specifications		EIA 481-1
W		8.0 \pm 0.3
P0		4.0 \pm 0.10
P1		4.0 \pm 0.10
P2		2.0 \pm 0.05
A0		1.45 \pm 0.10
B0		2.30 \pm 0.10
B1max.		4.35
D0		1.55 \pm 0.1, -0
F		3.5 \pm 0.05
E1		1.75 \pm 0.10
E2min.		6.25
T		0.25
T1max.		0.1
K0		0.74 \pm 0.1
Leader min.		390
Trailer min.		160
Reel Dimensions		
A max.		178
N min.		60
W1		9.0 \pm 0.5
W2		12.0 \pm 0.05

EIA Tape Component Dimensions



EIA Reel Dimensions



Storage And Handling

- Storage conditions : 40°C max, 70% R.H.
- Devices may not meet specified performance if storage conditions are exceeded.

Order Information

SL0805	'075	Packaging		
Product name Size 2012 mm / 0805 inch SL: surface mount device	Hold Current 0.75A	Max Voltage	SL0805075~SL0805300 : 4,000 pcs/reel SL0805350~SL0805800 : 3,000 pcs/reel	

Tape & reel packaging per EIA481-1

Labeling Information

